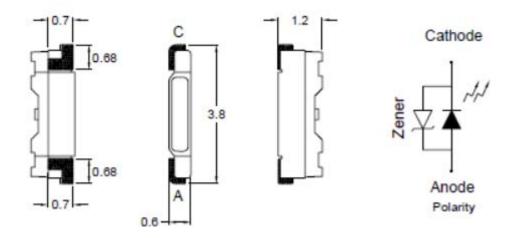


3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

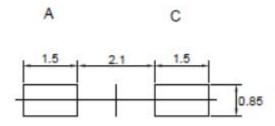
PACKAGE DIMENSION



Notes

- 1. All dimensions are in millimeters; tolerance is ±0.2mm unless otherwise noted
- 2. Specifications are subject to change without notice

RECOMMENDED SOLDERING PAD



Notes: All dimensions are in millimeters; toelrance is ±0.1mm unless otherwise noted

	Color				
Material	Emitted	Lens Color			
InGaN	White	Yellow Diffused			



3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

	Symbol	Rating	Unit		
Forward Current	I _F	30	mA		
Forward Peak Current (1/10 duty @10kHz)	I _{FP}	100	mA		
Power Dissipation	P _D	108	mW		
Reverse Current @5V	I _R	1	μA		
Electrostatic Discharge	ESD	2000	V		
Operating Temperature	T _{OPR}	-40~+100	°C		
Storage Temperature	T _{STG}	-40~+100	°C		
Thermal Resistance	Rth j-s	100	°C/W		
LED Junction Temperature	Tj	125	°C		

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

(**)							
	Cymahal	Took Condition	Rating			l luit	
	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Luminous Intensity	lv		1000		2000	mcd	
Chromaticity Coordinate	Х		0.287		0.318		
	Thomaticity Coordinate	Υ	I _F =20mA	0.276		0.329	
Forward Voltage	Vf		2.8		3.6	V	
Viewing Angle	2Θ1/2			110		deg	

Notes:

- 1. The Forward voltage data did not include ±0.1V testing tolerance
- 2. The luminous intensity data did not include ±15% testing tolerance
- 3. Color coordinates measurement tolerance is ±0.01



3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

LUMINOUS INTENSITY CLASSIFCATION

Bin Code	lv(mcd) at 20mA			
	Min.	Max.		
V21W11	1000	1200		
W12W15	1200	1400		
W21W24	1400	1600		
W25W33	1600	1800		
W34W37	1800	2000		

FORWARD VOLTAGE CLASSIFCATION

Bin Code	VF(V) at 20mA			
	Min.	Max.		
1	2.8	2.9		
2	2.9	3.0		
3	3.0	3.1		
4	3.1	3.2		
5	3.2	3.3		
6	3.3	3.4		
7	3.4	3.5		
8	3.5	3.6		

CHROMATICITY COORDINATES FOR BIN GRADING

			С	olor Coordi	nate at 20m	A		
Bin Code		1	2			3	4	
	Х	Υ	Х	Y	Х	Υ	X	Υ
W0	0.296	0.276	0.287	0.295	0.316	0.329	0.318	0.305



3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

TYPICAL ELECTRICAL-OPTICAL CHARACTERISTIC CURVES

WK CHIP

Fig.1 Forward current vs. Forward Voltage

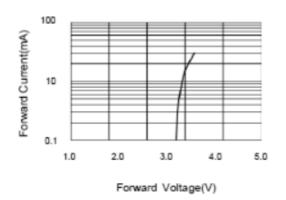


Fig.2 Relative Intensity vs. Forward Current

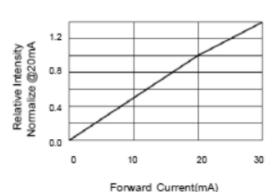
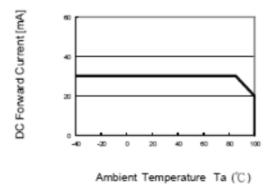


Fig.6 Forward Current vs. Temperature





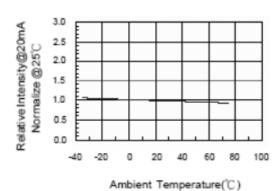


Fig.5 Luminous Spectrum(Ta=25°C)

SPECTRAL RADIANCE

Wavelength (nm)

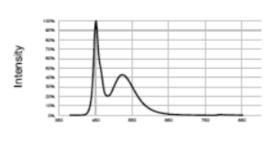
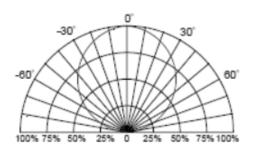


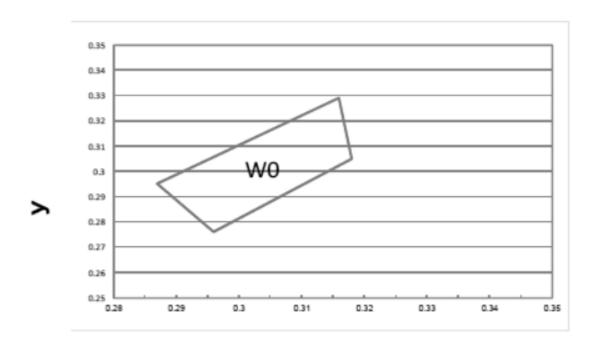
Fig.6 Directive Radiation





3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

CHROMATICITY DIAGRAM

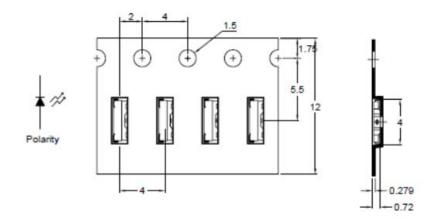


X



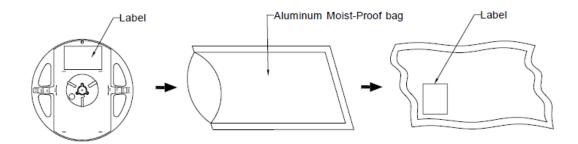
3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

CARRIER TAPE DIMENSION



Note: Tolerance is ±0.1mm; angle is ±0.5 unless otherwise mentioned

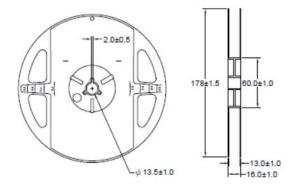
PACKING SPECIFICATIONS



Notes:

- 1. 12mm tape
- 2. 7inch reel

REEL DIMENSIONS



Notes: 3,000pcs / Reel

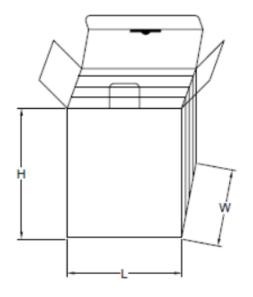
Tentative Date: 10/18/2018 Specifications are subject to change without notice.

American Opto Plus LED Corp. 1206 E. Lexington Ave., Pomona CA 91766 Tel: 909-465-0080 Fax: 909-465-0130 www.aopled.com



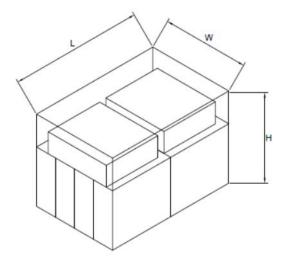
3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

BOX EXPLANATION



NOTES:

- 1. 4 BAG / INNER BOX
- 2. Inner box size: L X W X H 23cm X 8.5cm x 26cm



NOTES:

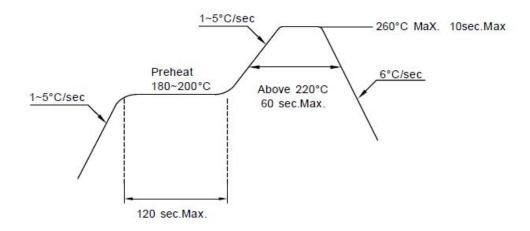
- 1. 10 INNER BOXES / CARTON
- 2. Carton size: L X W X H 58cm X 34cm x 35cm



3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

RECOMMENDED SOLDERING CONDITION

- Hand Solder
 Basic spec is ≤320°C for 3 seconds one time only
- 2. PB-Free Reflow Solder



Notes:

- 1. Reflow soldering should not be done more than 2 times
- 2. When soldering, do not put stress on the LEDs during heating
- 3. After soldering, do not warp the circuit board

PRECAUTION

Storage Time:

- 1. Calculated shelf life before opening is 12 months at <30°C and < 90% relative humidity(RH)
- 2. After bag is opened, devices which wil be subjected to reflow soldering or other high temperature processes must be
 - a. Assemebled within 168 hours in an enviornment of ≤30°C/60% RH or
 - b. Stored at ambient of 10% RH or less
- 3. Devices are required baking before assembly if:
 - a. Humidity indicator card reads >10%(for level 2a-5a) or >60%(for level 2) at ambient temperature 23±5°C
 - b. 2.a) or 2.b) doesn't meet
- 4. If baking is required, devices should be baked for >72 hours at 60±5°C/5% RH. Performing baking only once and using baked devices within 72 hours
- 5. MSL Level 3.



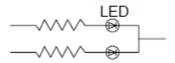
3.8 x 0.6 x 1.2 mm Side View PLCC White SMD LED (Automotive)

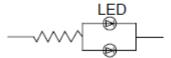
Drive method:

LED is a current operated device and therefore require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor places in series with the LED. Consider worst csae voltage variations than could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value

Circuit model A







- a. Recommended circuit
- b. The difference of brightness between LED could be found due to the VF-IF characteristics of LED

Cleaning:

1. Use alcohol based cleaning solvents such as isoproyl alcohol to clean the LED

Electrostatic Discharge(ESD)

 Static electricity or power surge will damage the LED. Use of a conductive wrist band or antielectrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded